# onsemi

# P-Channel Enhancement Mode Field-Effect Transistor

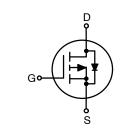
# **BSS84**

#### **General Description**

This P-channel enhancement-mode field-effect transistor is produced using **onsemi's** proprietary, high cell density, DMOS technology. This very high density process minimizes on-state resistance and to provide rugged and reliable performance and fast switching. The BSS84 can be used, with a minimum of effort, in most applications requiring up to 0.13 A DC and can deliver current up to 0.52 A. This product is particularly suited to low-voltage applications requiring a low-current high-side switch.

#### Features

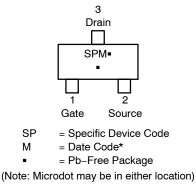
- $-0.13 \text{ A}, -50 \text{ V}, \text{R}_{\text{DS(on)}} = 10 \Omega \text{ at } \text{V}_{\text{GS}} = -5 \text{ V}$
- Voltage-Controlled P-Channel Small-Signal Switch
- High-Density Cell Design for Low RDS(on)
- High Saturation Current
- This Device is Pb–Free and Halogen Free





SOT-23-3 CASE 318-08

#### MARKING DIAGRAM



\*Date Code orientation and/or position may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
3SS84,	SOT-23-3	3000 /
3SS84–G	(Pb-Free)	Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Symbol	Parameter	Ratings	Unit
V <sub>DSS</sub>	Drain-Source Voltage	-50	V
V <sub>GSS</sub>	Gate-Source Voltage	±20	
I <sub>D</sub>	Drain Current – Continuous (Note 1)	-0.13	А
	Drain Current – Pulsed (Note 1)	-0.52	
PD	Maximum Power Dissipation (Note 1)	0.36	W
	Derate Above 25°C	2.9	mW/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	–55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering Purposes, 1/16" from Case for 10 s	300	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS $T_A$ = 25°C unless otherwise noted.

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1)	350	°C/W

### **ELECTRICAL CHARACTERISTICS** (Note 2) $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit			
OFF CHARAG	OFF CHARACTERISTICS								
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = –250 $\mu$ A	-50	-	-	V			
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C	-	-48	-	mV/°C			
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS}$ = -50 V, $V_{GS}$ = 0 V	-	-	-15	μΑ			
		$\label{eq:VDS} \begin{array}{l} V_{DS} = -50 \mbox{ V},  V_{GS} = 0 \mbox{ V}, \\ T_J = 125^\circ C \end{array}$	-	-	-60				
I <sub>GSS</sub>	Gate-Body Leakage	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V	_	-	±10	nA			

#### ON CHARACTERISTICS (Note 2)

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -1 \text{ mA}$	-0.8	-1.7	-2	V
$\frac{\Delta V_{\text{GS(th)}}}{\Delta T_{\text{J}}}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -1$ mA, Referenced to 25°C	-	3	-	mV/°C
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -5 \text{ V}, \text{ I}_{D} = -0.10 \text{ A}$	-	1.2	10	Ω
		$V_{GS}$ = –5 V, $I_D$ = –0.10 A, $T_J$ = 125°C	-	1.9	17	
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS}$ = -5 V, $V_{DS}$ = -10 V	-0.6	-	-	А
<b>g</b> fs	Forward Transconductance	$V_{DS} = -25 \text{ V}, \text{ I}_{D} = -0.10 \text{ A}$	0.05	0.6	-	S

#### DYNAMIC CHARACTERISTICS

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz	-	73	-	pF
C <sub>oss</sub>	Output Capacitance		-	10	-	
C <sub>rss</sub>	Reverse Transfer Capacitance		-	5	-	
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> = 15 mV, f = 1.0 MHz	-	9	-	Ω

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#### **ELECTRICAL CHARACTERISTICS** (Note 2) $T_A = 25^{\circ}C$ unless otherwise noted. (continued)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
SWITCHING	CHARACTERISTICS (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = -30 \text{ V}, \text{ I}_D = -0.27 \text{ A},$ $V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	-	2.5	5.0	ns
t <sub>r</sub>	Turn–On Rise Time	$v_{\rm GS} = -10$ V, $R_{\rm GEN} = 6$ 22	-	6.3	13	
t <sub>d(off)</sub>	Turn-Off Delay Time		-	10	20	
t <sub>f</sub>	Turn-Off Fall Time		-	4.8	9.6	
Qg	Total Gate Charge	$V_{DS} = -25 \text{ V}, \text{ I}_D = -0.10 \text{ A},$ $V_{GS} = -5 \text{ V}$	-	0.9	1.3	nC
Q <sub>gs</sub>	Gate-Source Charge	$v_{GS} = -3 v$	-	0.2	-	
Q <sub>gd</sub>	Gate-Drain Charge		-	0.3	-	

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

۱ <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current		-	-	-0.13	А
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0$ V, $I_{S} = -0.26$ A (Note 2)	-	-0.8	-1.2	V
t <sub>rr</sub>	Diode Reverse Recovery Time	$I_F = -0.1 \text{ A}, d_{if}/d_t = 100 \text{ A}/\mu \text{s}$	-	10	-	ns
Q <sub>rr</sub>	Diode Reverse Recovery Charge	(Note 2)	-	3	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

 R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JA</sub> is guaranteed by design while R<sub>0JA</sub> is determined by the user's board design.

a) 350°C/W when mounted on a minimum pad.

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2. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%

#### **TYPICAL CHARACTERISTICS**

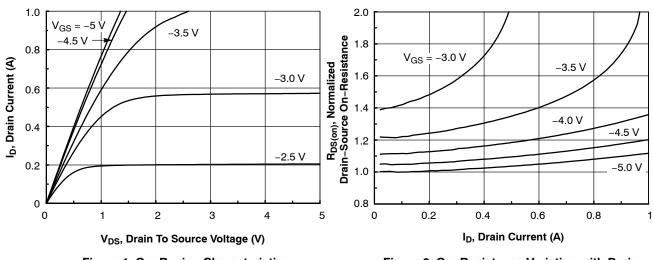
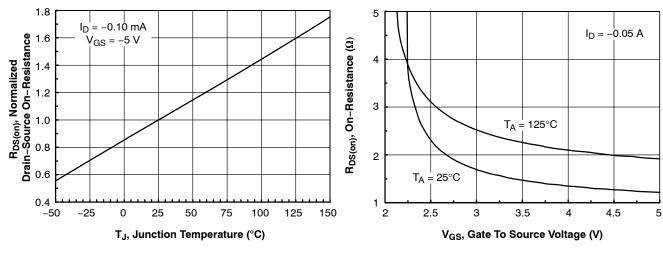




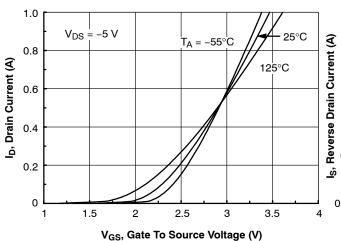
Figure 2. On–Resistance Variation with Drain Current and Gate Voltage

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#### TYPICAL CHARACTERISTICS (continued)









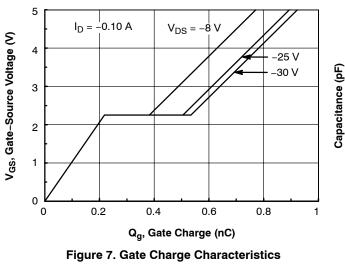
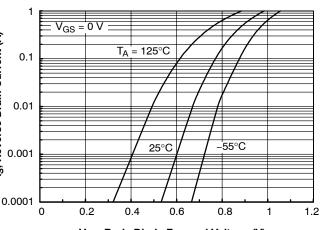


Figure 4. On-Resistance Variation with Gate-to-Source Voltage



V<sub>SD</sub>, Body Diode Forward Voltage (V)

Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

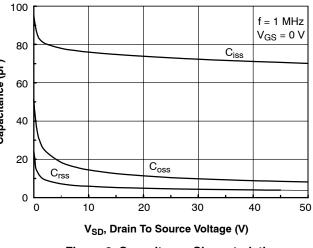


Figure 8. Capacitance Characteristics

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#### TYPICAL CHARACTERISTICS (continued)

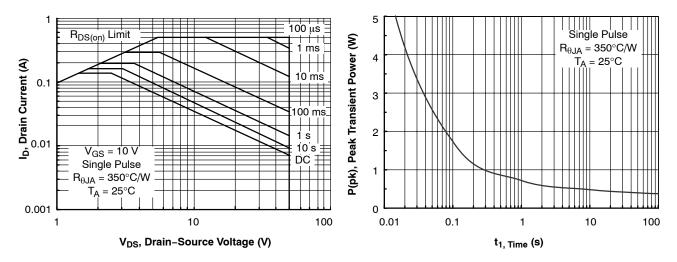




Figure 10. Single Pulse Maximum Power Dissipation

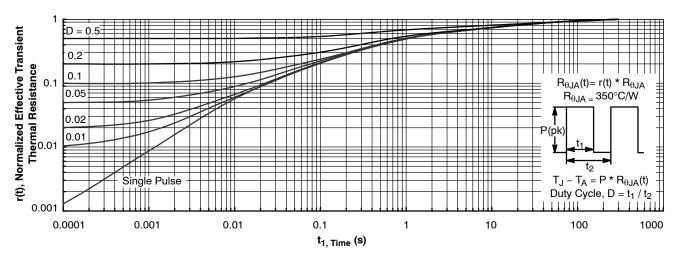


Figure 11. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note 1a. Transient thermal response will change depending on the circuit board design.





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